



Memory 4GB 1600MHz CL11 DDR3 SODIMM RP



General Description

Apacer DV.04G2K.KAM is a 512M x 64 DDR3 SDRAM (Synchronous DRAM) SO-DIMM. This high-density memory module consists of 8 pieces 512M x 8 bits with 8 banks DDR3 synchronous DRAMs in BGA packages and a 2K EEPROM. The module is a 204-pins small-outlined, dual in-line memory module and is intended for mounting into a connector socket. Decoupling capacitors are mounted on the printed circuit board for each DDR3 SDRAM. The following provides general specifications of this module.

Part Number	Bandwidth	Speed Grade	Max Frequency	CAS Latency
DV.04G2K.KAM	12.8 GB/sec	1600 Mbps	800 MHz	CL11

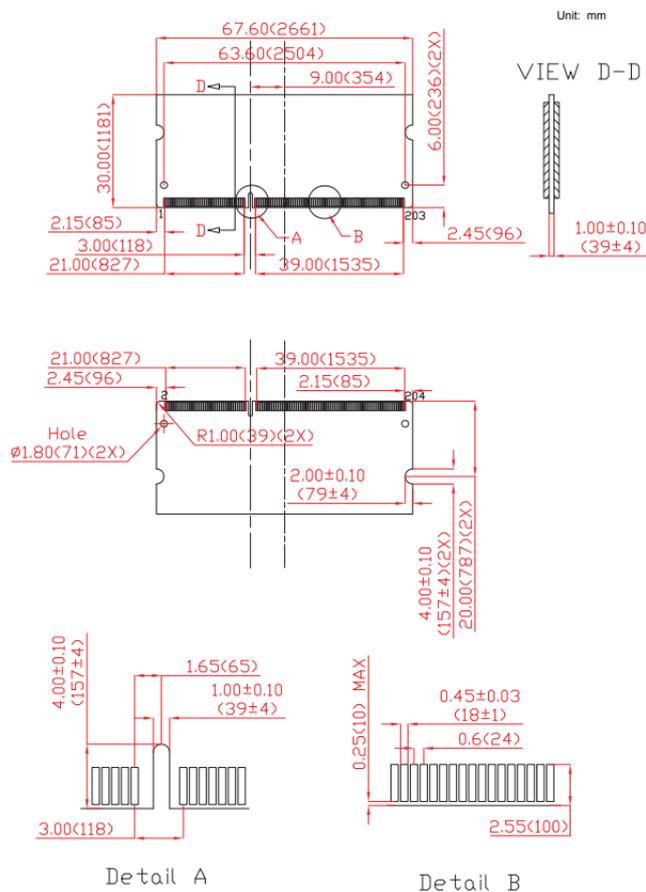
Density	Organization	Component	Rank
4GB	512M x 64	512M x8*8	1

Specifications:

- ◆ On-DIMM thermal sensor : No
- ◆ Organization: 512 words x 64 bits, 1 rank
- ◆ Integrating 8 pieces of 4G bits DDR3 SDRAM sealed in FBGA
- ◆ Package: 204-pin socket type small outline dual in-line memory module (SO-DIMM)

- ◆ PCB: height 30.0mm, lead pitch 0.6 mm (pin), lead-free (RoHS compliant)
- ◆ Power supply VDD: 1.35V (+0.1V ~ -0.067V)
- ◆ Backward compatible to VDD = VDDQ = 1.5V ± 0.075V -Supports DDR3L devices to be backward compatible in 1.5V applications
- ◆ Serial Presence Detect (SPD)
- ◆ Eight Internal banks for concurrent operation (components)
- ◆ Interface: SSTL_13
- ◆ Burst lengths (BL): 8 and 4 with Burst Chop (BC)
- ◆ CAS Latency (CL): 6, 7, 8, 9, 10, 11
- ◆ CAS Write Latency (CWL): 5, 6, 7, 8
- ◆ Supports auto pre-charge option for each burst access
- ◆ Supports auto-refresh/self-refresh
- ◆ Refresh cycles: 7.8 μs at 0°C ≤ TC ≤ +85°C

Mechanical Drawing:



(All dimensions are in millimeters with ±0.15mm tolerance unless specified otherwise.)